IN THE CLAIMS

Docket No.: H0498.70217US02

Please replace all prior versions, and listings, of claims in the application with the following list of claims:

- 1-125. (Cancelled)
- 126. (New) A method, comprising:

providing a semiconductor nanoscale wire;

patterning a mask on the nanoscale wire to define at least a first portion not covered by the mask and a second portion covered by the mask;

exposing the first portion but not the second portion to a bulk metal; and diffusing at least a portion of the bulk metal into the first portion of the nanoscale wire.

- 127. (New) The method of claim 126, wherein the semiconductor nanoscale wire comprises silicon.
- 128. (New) The method of claim 127, comprising diffusing at least a portion of the bulk metal into the first portion of the nanoscale wire to form a metal silicide having a stoichiometric ratio of silicon and at least one metal.
- 129. (New) The method of claim 128, wherein the metal silicide comprises nickel silicide.
- 130. (New) The method of claim 126, wherein the bulk metal comprises a transition metal.
- 131. (New) The method of claim 126, wherein the bulk metal comprises nickel.
- 132. (New) The method of claim 126, wherein the first portion of the nanoscale wire has a smallest dimension less than 200 nm.

133. (New) The method of claim 126, wherein the nanoscale wire is a single crystal.

3

- 134. (New) The method of claim 126, wherein the mask comprises photoresist.
- 135. (New) The method of claim 126, wherein the mask comprises a second nanoscale wire.
- 136. (New) The method of claim 135, wherein the second nanoscale wire comprises a core and a shell.
- 137. (New) The method of claim 126, wherein the nanoscale wire is a nanowire.
- 138. (New) The method of claim 126, comprising diffusing at least a portion of the bulk metal into the first portion of the nanoscale wire such that the first region has a resistivity of less than about 60 microOhm cm.
- 139. (New) The method of claim 126, comprising diffusing at least a portion of the bulk metal into the first portion of the nanoscale wire such that the first region is able to carry a current density of at least about 10⁸ A/cm².
- 140. (New) A method, comprising:

promoting a method comprising an act of diffusing at least a portion of a bulk metal into at least a portion of a semiconductor nanoscale wire, the bulk metal and the semiconductor nanoscale wire being adjacent, wherein the semiconductor nanoscale wire comprises at least one portion having a smallest dimension of less than about 500 nm.

- 141. (New) The method of claim 140, wherein the bulk metal comprises nickel.
- 142. (New) The method of claim 140, wherein the semiconductor nanoscale wire comprises silicon.

- Docket No.: H0498.70217US02
- 143. (New) The method of claim 140, comprising promoting a method comprising an act of diffusing at least a portion of the bulk metal into at least a portion of the semiconductor wire to form a metal silicide.
- 144. (New) The method of claim 143, wherein the metal silicide has a stoichiometric ratio of silicon and at least one metal.
- 145. (New) The method of claim 144, wherein the metal silicide comprises nickel silicide.